# Switch-mode Power Rectifier 60 V, 10 A

### **Features and Benefits**

- Low Forward Voltage
- Low Power Loss/High Efficiency
- High Surge Capability
- 10 A Total (5 A Per Diode Leg)
- Guard–Ring for Stress Protection
- These Devices are Pb-Free and are RoHS Compliant

### Applications

- Power Supply Output Rectification
- Power Management
- Instrumentation

### **Mechanical Characteristics:**

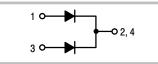
- Case: Epoxy, Molded
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight (Approximately): 1.9 Grams
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds



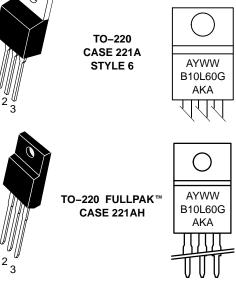
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SCHOTTKY BARRIER RECTIFIER 10 AMPERES, 60 VOLTS







A	= Assembly Location
Y	= Year
WW	= Work Week
B10L60	= Device Code
G	= Pb-Free Device
AKA	= Polarity Designator

### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

#### MAXIMUM RATINGS (Per Diode Leg)

Rating	Rating Symbol Value		Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V	
Average Rectified Forward Current (Rated $V_R$ ) T <sub>C</sub> = 140°C	(Per Leg) (Per Device)	I <sub>F(AV)</sub>	5 10	A	
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)		I <sub>FSM</sub>	200	A	
Operating Junction Temperature (Note 1)		Τ <sub>J</sub>	-55 to +150	°C	
Storage Temperature		T <sub>stg</sub>	-65 to +175	°C	
ESD Ratings: Machine Model = C Human Body Model = 3B			> 400 > 8000	V	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Maximum Thermal Resistance MBR10L60CTG Junction-to-Case Junction-to-Ambient MBRF10L60CTG Junction-to-Case Junction-to-Ambient	R <sub>θJC</sub> R <sub>θJA</sub> R <sub>θJC</sub> R <sub>θJA</sub>	2.8 70 5.7 75	°C/W

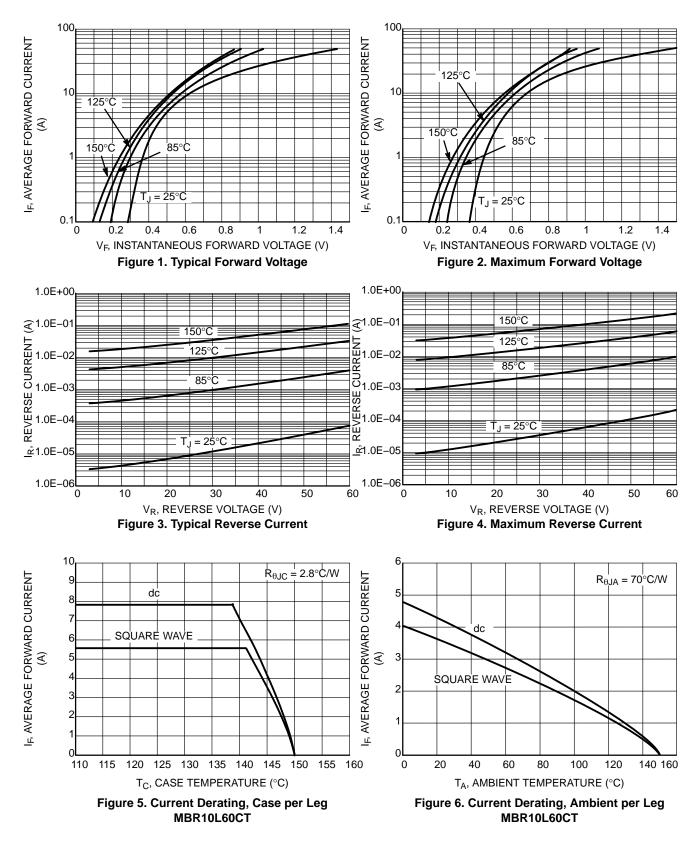
#### ELECTRICAL CHARACTERISTICS (Per Diode Leg)

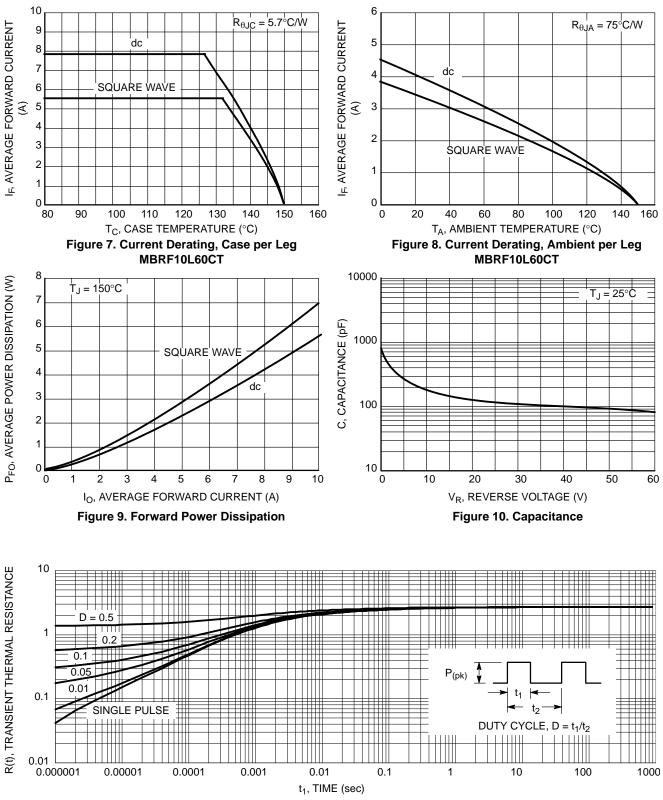
Rating	Symbol	Тур	Max	Unit
	VF	0.49 0.43 0.60 0.53	0.57 0.49 0.66 0.61	V
Maximum Instantaneous Reverse Current (Note 2) (Rated DC Voltage, $T_C = 25^{\circ}C$ ) (Rated DC Voltage, $T_C = 125^{\circ}C$ )	İR	77 33	220 60	μA mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .

### **DEVICE ORDERING INFORMATION**

Device Order Number	Package Type	Shipping
MBR10L60CTG	TO–220 (Pb–Free)	50 Units / Rail
MBRF10L60CTG	TO–220 FULLPAK (Pb–Free)	50 Units / Rail







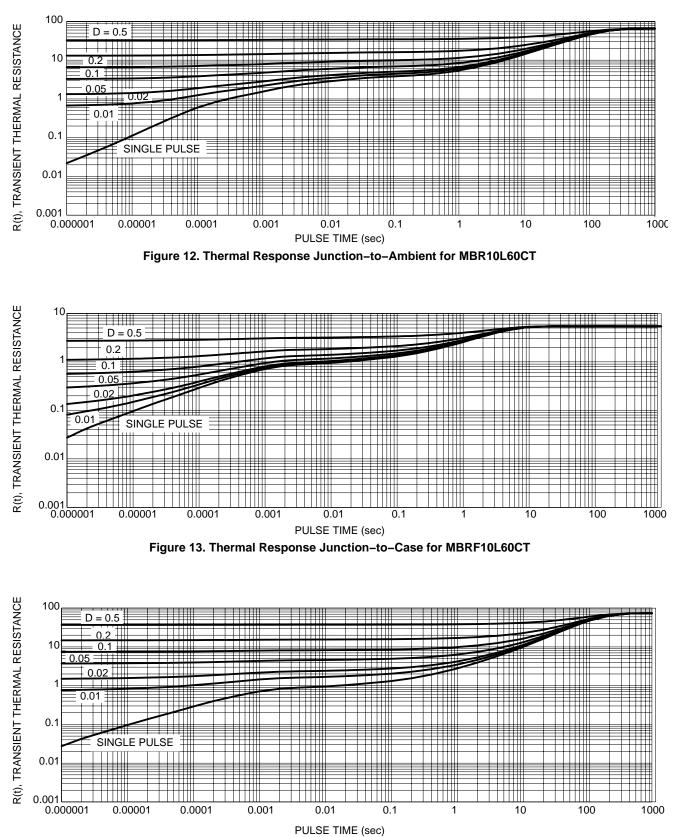
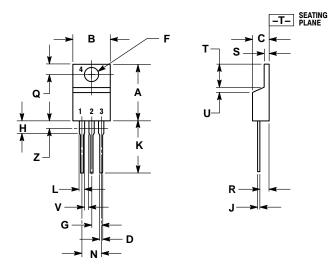


Figure 14. Thermal Response Junction-to-Ambient for MBRF10L60CT

### PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AH** 



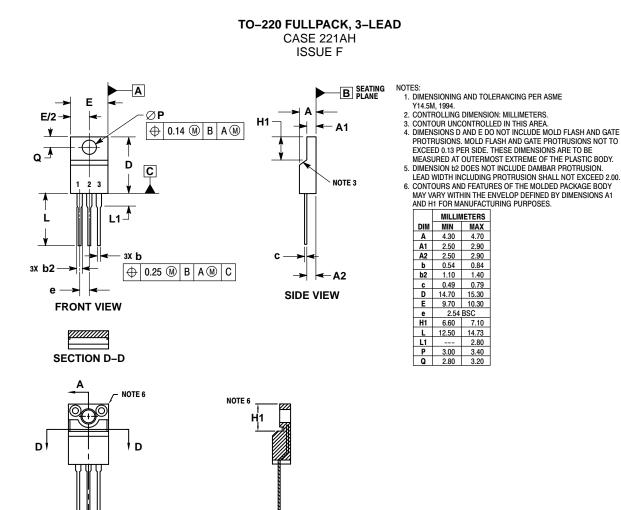
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES MIN MAX		MILLIN	IETERS
DIM			MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
κ	0.500	0.562	12.70	14.27
Г	0.045	0.060	1.15	1.52
Ν	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
۷	0.045		1.15	
Z		0.080		2.04

STYLE 6: PIN 1. ANODE 2. CATHODE 3. ANODE 4. CATHODE

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#### PACKAGE DIMENSIONS



**SECTION A-A** 

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